



07-28-03 41

17517

Express Mail No. EV 313 841 308 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Robert J. Small, et al.

Serial No.: 09/903,064

Art Unit: 1751

Filed: July 10, 2001

Examiner: Gregory E. Webb

For: COMPOSITIONS FOR
CLEANING ORGANIC AND
PLASMA ETCHED RESIDUES
FOR SEMICONDUCTOR
DEVICES

Attorney Docket No: 8317-091-999

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JUL 31 2003
TC 1700

FEE TRANSMITTAL SHEET

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The fee required to be filed with the accompanying amendment of even date herewith concerning the above-identified application has been estimated to be \$252.00.

The claim amendment fee has been estimated as shown below:

(Col. 1)		(Col. 2)		(Col. 3)		<input type="checkbox"/> SMALL ENTITY		<input checked="" type="checkbox"/> OTHER THAN A SMALL ENTITY	
CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID		PRESENT EXTRA		RATE	ADDIT. FEE	OR	ADDIT. FEE
TOTAL	17	MINUS	31	0	x 9	\$		x 18	\$ 0.00
INDEP.	7	MINUS	4	3	x 42	\$		x 84	\$ 252.00
						\$		\$	0.00
<input type="checkbox"/> FIRST PRESENTATION OF MULTIPLE DEP. CLAIM						TOTAL	\$	OR	TOTAL \$ 252.00

Please charge the required fee to Pennie & Edmonds LLP Deposit Account No. 16-1150.
A copy of this sheet is enclosed.

Date: July 24, 2003

Respectfully submitted,

James S. McDonald (Reg. No. 41,229)

For: Victor N. Balancia (Reg. No. 31,231)

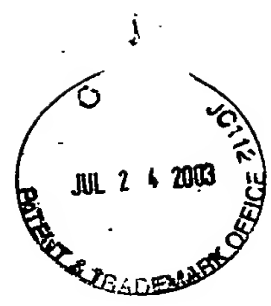
PENNIE & EDMONDS LLP

3300 Hillview Avenue

Palo Alto, California 94304

(650) 493-4935

Enclosure



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Robert J. Small, et al.

Application No.: 09/903,064

Group Art Unit: 1751

Filed: July 10, 2001

Examiner: Gregory E. Webb

For: *Compositions for Cleaning Organic
and Plasma Etched Residues for
Semiconductor Devices*

Attorney Docket No.: 8317-091-999

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AMENDMENT AND RESPONSE UNDER 37 C.F.R. § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The enclosed Amendment is in response to the Office Action dated February 14, 2003 for the above identified patent application.

Petition for Extension of Time under 37 CFR 1.136. It is respectfully requested that the time for response to the Office Action dated February 14, 2003 be extended for a period of 1 month(s) from June 24, 2003 to and including July 24, 2003. The fee for this extension is estimated to be \$110.

The Commissioner is hereby authorized to charge any required fee(s) to Pennie & Edmonds LLP Deposit Account No. 16-1150. A copy of this sheet is enclosed for such purpose.

This response follows the revised form as now permitted by the USPTO.¹

07/30/2003 MMEKONEN 00000020 161150 09903064

01 FC:1201 168.00 DA

07/31/2003 MMEKONEN 00000020 161150 09903064

02 FC:1251 110.00 DA

¹ See, <http://www.uspto.gov/web/offices/pac/dapp/opla/preognotice/moreinfoamdtprac.htm>.

07/31/2003 WADDELRI 00000137 161150 09903064
01 FC:1201 84.00 DA



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Dear Sir:

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Petition for Extension of Time under 37 CFR 1.136. It is respectfully requested that the time for response to the Office Action dated ~~February 14~~ **March 24**, 2003 be extended for a period of 1 month(s) from June 24, 2003 to and including July 24, 2003. The fee for this extension is estimated to be \$110.

The Commissioner is hereby authorized to charge any required fee(s) to Pennie & Edmonds LLP Deposit Account No. 16-1150. A copy of this sheet is enclosed for such purpose.

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